COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

X is attached hereto.					
was filed on as Application Serial No		and was amended on			
specification, including the I acknowledge the application in accordance I hereby claim foreicapplication(s) for patent	ne claims, as amende duty to disclose info e with Title 37, Code of gn priority benefits un or inventor's certific tent or inventor's cert ed:	and understand the content of by any amendment referred rmation which is material to of Federal Regulations, § 1. der Title 35, United States Co ate listed below and have ificate having a filing date be	ed to above. the patenta 56(a). code, § 119 also identific	ability of this of any foreign ed below any	
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
92104352	Taiwan, R.O.C.	2003/3/3	Х		
		0)		ication and to	
SEND CORRESPON	DENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
JIANQ CHYUN Inte 7F1, No. 100, Roo Taipei 100, Taiwan, TEL: 886-2-2369 28 FAX: 886-2-2369 72	sevelt Rd., Sec. 2, R.O.C.	fice Belind	da Lee		

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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